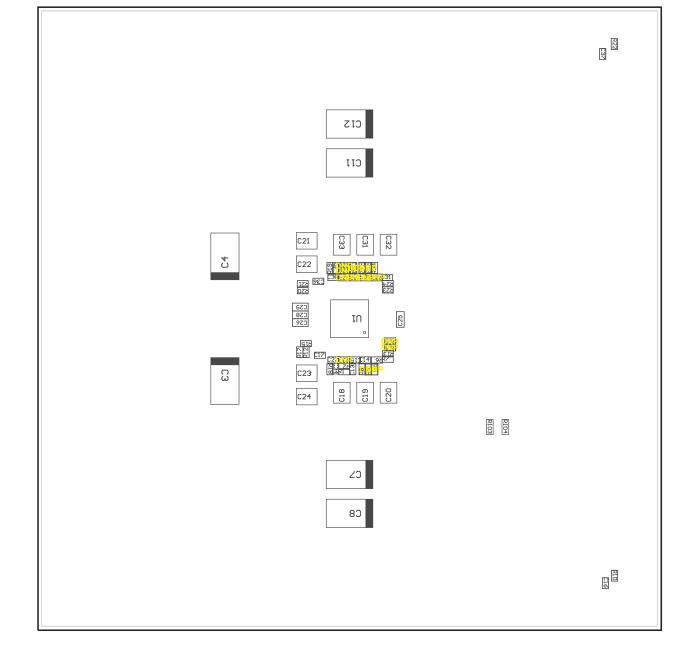


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.

ASSEMBLY VARIANT: 2-PHASE

PCB VIEWED FROM TOP SIDE	BOARD #: PMP8342	REV: B	SVN REV	: Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 12/18/	2014 9:46:03	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 2-PHASE

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP8342	REV: B	SVN REV:	Not In VersionControl
PLOT NAME = Bottom Assembly Drawing	GENERATED : 12/18/	2014 9:46:05	PM	TEXAS INSTRUMENTS

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